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# FODM3010，FODM3011，FODM3012，FODM3021， FODM3022，FODM3023 <br> 4－Pin Full Pitch Mini－Flat Package Random－Phase Triac Driver Output Optocouplers 

## Features

■ Compact 4－pin surface mount package（2．4 mm maximum standoff height）
－Peak blocking voltage 250V（FODM301X）
400V（FODM302X）
■ Available in tape and reel quantities of 500 and 2500
－Applicable to Infrared Ray reflow（ $230^{\circ} \mathrm{C}$ max， 30 seconds．）
－BSI，CSA and VDE certifications pending
－UL（File\＃E90700）certified

## Applications

－Industrial controls
－Traffic lights
－Vending machines
－Solid state relay
－Lamp ballasts
－Solenoid／valve controls
－Static AC power switch
－Incandescent lamp dimmers
－Motor control

## Package Dimensions



NOTE
All dimensions are in inches（millimeters）

## Description

The FODM301X and FODM302X series consists of a GaAs infrared emitting diode driving a silicon bilateral switch housed in a compact 4－pin mini－flat package．The lead pitch is 2.54 mm ． They are designed for interfacing between electronic controls and power triacs to control resistive and inductive loads for $115 \mathrm{~V} / 240 \mathrm{~V}$ operations．

Absolute Maximum Ratings $\left(\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}\right.$ unless otherwise specified)

| Parameter | Symbol | Value | Units |
| :---: | :---: | :---: | :---: |
| TOTAL PACKAGE |  |  |  |
| Storage Temperature | $\mathrm{T}_{\text {STG }}$ | -40 to +125 | ${ }^{\circ} \mathrm{C}$ |
| Junction Temperature | $\mathrm{T}_{J}$ | 125 | ${ }^{\circ} \mathrm{C}$ |
| Operating Temperature | ToPR | -40 to +100 | ${ }^{\circ} \mathrm{C}$ |
| EMITTER |  |  |  |
| Continuous Forward Current | $I_{F(a v g)}$ | 60 | mA |
| Peak Forward Current ( 1 ¢s pulse, 300 pps.) | $\mathrm{I}_{\mathrm{F}(\mathrm{pk})}$ | 1 | A |
| Reverse Input Voltage | $\mathrm{V}_{\mathrm{R}}$ | 3 | V |
| Power Dissipation (No derating required over operating temp. range) | $\mathrm{P}_{\mathrm{D}}$ | 100 | mW |
| DETECTOR |  |  |  |
| On-State RMS Current | $\mathrm{I}_{\text {T(RMS) }}$ | 70 | mA (RMS) |
| Off-State Output Terminal Voltage FODM3010/1/2 | $\mathrm{V}_{\text {DRM }}$ | 250 | V |
| FODM3021/2/3 |  | 400 |  |
| Power Dissipation (No derating required over operating temp. range) | $\mathrm{P}_{\mathrm{D}}$ | 300 | mW |

Electrical Characteristics ( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ )
Individual Component Characteristics

| Parameter | Test Conditions | Symbol | Device | Min | Typ* | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| EMITTER |  |  |  |  |  |  |  |
| Input Forward Voltage | $\mathrm{I}_{\mathrm{F}}=10 \mathrm{~mA}$ | $\mathrm{V}_{\mathrm{F}}$ | All |  | 1.20 | 1.5 | V |
| Reverse Leakage Current | $\mathrm{V}_{\mathrm{R}}=3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | $\mathrm{I}_{\mathrm{R}}$ | All |  | 0.01 | 100 | $\mu \mathrm{A}$ |
| DETECTOR |  |  |  |  |  |  |  |
| Peak Blocking Current Either Direction | Rated $\mathrm{V}_{\text {DRM }}, \mathrm{I}_{\mathrm{F}}=0$ (note 1) | IDRM | All |  | 2 | 100 | nA |
| Peak On-State Voltage Either Direction | $\mathrm{I}_{\text {TM }}=100 \mathrm{~mA} \mathrm{peak}$ | $\mathrm{V}_{\text {TM }}$ | All |  | 1.7 | 3 | V |
| Critical Rate of Rise of Off-State Voltage | $\mathrm{I}_{\mathrm{F}}=0$ (Figure 8, note 2) | dV/dt | All |  | 10 |  | V/us |

Transfer Characteristics ( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ )

| DC Characteristics | Test Conditions | Symbol | Device | Min | Typ* | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| LED Trigger Current | Main Terminal Voltage $=3 \mathrm{~V}$ (note 3 ) | $\mathrm{I}_{\text {FT }}$ | FODM3010 |  |  | 15 | mA |
|  |  |  | FODM3021 |  |  |  |  |
|  |  |  | FODM3011 |  |  | 10 |  |
|  |  |  | FODM3022 |  |  |  |  |
|  |  |  | FODM3012 |  |  | 5 |  |
|  |  |  | FODM3023 |  |  |  |  |
| Holding Current, Either Direction |  | $\mathrm{I}_{\mathrm{H}}$ | All |  | 300 |  | $\mu \mathrm{A}$ |

## Isolation Characteristics

| Characteristic | Test Conditions | Symbol | Device | Min | Typ* | Max | Unit |
| :--- | ---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Steady State Isolation Voltage | (1 Minute) | $\mathrm{V}_{\text {ISO }}$ | All | 3750 |  |  | VRMS |

* All typicals at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$


## Note

1. Test voltage must be applied within dv/dt rating.
2. This is static $\mathrm{dv} / \mathrm{dt}$. See Figure 1 for test circuit Commutating dv/dt is function of the load-driving thyristor(s) only.
3. All devices are guaranteed to trigger at an $\mathrm{I}_{\mathrm{F}}$ value less than or equal to $\mathrm{max}_{\mathrm{I}} \mathrm{I}_{\mathrm{F}}$. Therefore, recommended operating $\mathrm{I}_{\mathrm{F}}$ lies between max $\mathrm{I}_{\mathrm{FT}}$ ( 15 mA for FODM3010 and FODM3021, 10 mA for FODM3011 and FODM3022, 5 mA for FODM3012 and FODM3023) and absolute max $\mathrm{I}_{\mathrm{F}}(60 \mathrm{~mA})$.

## Typical Performance Curves






## Typical Performance Curves



Fig. 7 On-State Characteristics


## Typical Performance Curves



Figure 8. Static dv/dt Test Circuit

NOTE: This optoisolator should not be used to drive a load directly. It is intended to be a trigger device only.


Figure 9. Resistive Load


Figure 10. Inductive Load with Sensitive Gate Triac ( $\mathbf{I}_{\mathrm{GT}} \leq 15 \mathrm{~mA}$ )


Figure 11. Inductive Load with Sensitive Gate Triac ( $\mathrm{I}_{\mathrm{GT}} \leq 15 \mathrm{~mA}$ )


In this circuit the "hot" side of the line is switched and the load connected to the cold or ground side.
The 39 ohm resistor and $0.01 \mu \mathrm{~F}$ capacitor are for snubbing of the triac, and the 470 ohm resistor and 0.05 mF capacitor are for snubbing the coupler. These components may or may not be necessary depending upon the particular and load used.

Figure 12. Typical Application Circuit

Ordering Information

| Option | Description |
| :---: | :---: |
| V | VDE Approved |
| R1 | Tape and Reel (500 units) |
| R2 | Tape and Reel (2500 units) |
| R3 | Tape and Reel (500 units; unit $180^{\circ}$ rotated) |
| R4 | Tape and Reel (2500 units; unit $180^{\circ}$ rotated) |
| R1V | Tape and Reel (500 units) and VDE Approved |
| R2V | Tape and Reel (2500 units) and VDE Approved |
| R3V | Tape and Reel (500 units; unit $180^{\circ}$ rotated) and VDE Approved |
| R4V | Tape and Reel (2500 units; unit $180^{\circ}$ rotated) and VDE Approved |

## Marking Information



| Definitions |  |
| :---: | :--- |
| 1 | Fairchild logo |
| 2 | Device number |
| 3 | VDE mark (Note: Only appears on parts ordered with VDE option - <br> See order entry table) |
| 4 | One digit year code |
| 5 | Two digit work week ranging from '01' to ‘53' |
| 6 | Assembly package code |




## Footprint Drawing for PCB Layout



Recommended Infrared Reflow Soldering Profile


- Peak reflow temperature: $230^{\circ} \mathrm{C}$ (package surface temperature) for 30 seconds
- Time of temperature higher than $210^{\circ} \mathrm{C}: 60$ seconds or less
- One time soldering reflow is recommended

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| :---: | :---: | :---: | :---: | :---: |
| ActiveArray ${ }^{\text {TM }}$ | FASTr ${ }^{\text {TM }}$ | LittleFET ${ }^{\text {tM }}$ | PowerTrench ${ }^{\circledR}$ | SyncFET ${ }^{\text {TM }}$ |
| Bottomless ${ }^{\text {TM }}$ | FPS ${ }^{\text {TM }}$ | MICROCOUPLER ${ }^{\text {TM }}$ | QFET ${ }^{\circledR}$ | TinyLogic ${ }^{\circledR}$ |
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| CROSSVOLT ${ }^{\text {m }}$ | $\mathrm{GTO}^{\text {¹ }}$ | MICROWIRE ${ }^{\text {™ }}$ | Quiet Series ${ }^{\text {™ }}$ | UHC ${ }^{\text {™ }}$ |
| DOME ${ }^{\text {™ }}$ | $\mathrm{HiSeC}^{\text {m }}$ | MSX ${ }^{\text {™ }}$ | RapidConfigure ${ }^{\text {TM }}$ | UltraFET ${ }^{\text {® }}$ |
| EcoSPARK ${ }^{\text {™ }}$ | $1^{2} \mathrm{C}^{\text {™ }}$ | MSXPro ${ }^{\text {™ }}$ | RapidConnect ${ }^{\text {™ }}$ | UniFET ${ }^{\text {TM }}$ |
| $\mathrm{E}^{2} \mathrm{CMOS}^{\text {™ }}$ | $i-L O^{\text {TM }}$ | OCX ${ }^{\text {¹ }}$ | $\mu$ SerDes ${ }^{\text {TM }}$ | VCX ${ }^{\text {TM }}$ |
| EnSigna ${ }^{\text {TM }}$ | ImpliedDisconnect ${ }^{\text {TM }}$ | OCXPro ${ }^{\text {т }}$ | SILENT SWITCHER ${ }^{\circledR}$ | Wire ${ }^{\text {TM }}$ |
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| FACT Quiet Series ${ }^{\text {TM }}$ |  | OPTOPLANAR ${ }^{\text {TM }}$ | SPM ${ }^{\text {™ }}$ |  |
|  |  | PACMAN ${ }^{\text {TM }}$ | Stealth ${ }^{\text {TM }}$ |  |
| Across the board. Around the world. ${ }^{\text {TM }}$ |  | РОР ${ }^{\text {т }}$ | SuperFET ${ }^{\text {tm }}$ |  |
| The Power Franchise ${ }^{\circledR}$ |  | Power247 ${ }^{\text {™ }}$ | SuperSOT ${ }^{\text {TM }}$-3 |  |
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